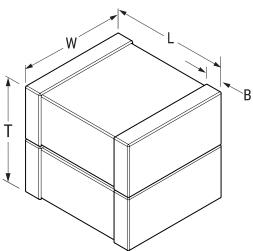
## C2220C362KZGLCAUTO

KONNEKT Auto COG, Ceramic, 3,600 pF, 10%, 2,500 VDC, COG





	Click here for t	the 3D model.	Typical Comp Chip Size Shelf Life MSL
Dimensions			Specification
L		5.7mm +/-0.4mm	Capacitance
W		5mm +/-0.4mm	Measuremen
Т		5.1mm +/-0.4mm	Tolerance

0.6mm +/-0.35mm

Packaging Specifications			
Packaging	T&R, 180mm, Plastic Tape		
Packaging Quantity	300		

В

General Information	
Series	KONNEKT Auto COG
Style	KONNEKT
Description	SMD, MLCC, KONNEKT, Ultra- Stable, Class I
Features	High Density Packaging
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	650 mg
Chip Size	2220-2
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	3,600 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	2500 VDC
Dielectric Withstanding Voltage	3,000 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 PPM/C
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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